

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	9	((transistor\$1 with heat\$6) same (transistor with sens\$6)) and (silicon near island)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/06 13:38
S2	4	("6329272") or ("5600174").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/08/06 13:37
S3	9	(((transistor\$1 or "FET") with heat\$6) same ((transistor\$1 or "FET") with sens\$6)) and (silicon near island)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/06 13:41
S4	7	((transistor\$1 or "FET") with heat\$6 with sens\$6) and (silicon near island)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/06 13:42
S5	18	((transistor\$1 or "FET") with (heat\$6 or temperature) with sens\$6) and (silicon near island)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/06 14:25
S6	6	((transistor\$1 or "FET") with (heat\$6 or temperature)) and (silicon near island) and (temperature near5 calculat\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/06 14:37
S7	640	((transistor\$1 or "FET") with (heat\$6 or temperature)) and silicon and (temperature near5 calculat\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/06 14:59
S8	0	S7 and "SOI" and (slef\$heating)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/06 15:00
S9	12	S7 and "SOI" and (self\$heating)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/06 17:14

S10	6	(("6252277") or ("6261935") or ("6573169")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/08/06 17:17
S11	1003	(change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 17:24
S12	0	S11 and ((generat \$6 near5 heat) with "FET")	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/06 17:20
S13	0	S11 and (heat with "FET")	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/06 17:21
S14	13	S11 and (heat\$3 with "FET")	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 17:25
S15	3639	((702/57) or (702/60) or (702/65) or (702/93) or (702/99) or (702/116) or (702/119) or (702/130) or (702/136)).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/08/07 17:25
S16	3	S15 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 17:27
S17	0	S16 and (heat\$3 with "FET")	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 17:28
S18	3983	((702/170) or (702/182) or (702/183) or (702/189) or (702/193)).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/08/07 17:26
S19	1	S18 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 17:30
S20	0	S19 and (heat\$3 with "FET")	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 17:31
S24	2732	(257/59).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/08/07 17:30

S25	6	S24 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 17:32
S26	0	S25 and (heat\$3 with "FET")	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 17:31
S27	3535	(257/347).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/08/07 17:31
S28	5	S27 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 17:42
S29	1809	(257/401).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/08/07 17:36
S30	2	S29 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 18:43
S31	915	(257/577).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/08/07 17:43
S32	3	S31 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 18:56
S33	1749	(257/706).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/08/07 18:55
S34	0	S33 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 18:57
S35	403	(438/163).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/08/07 18:56
S36	0	S35 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/08/07 21:40
S37	2	("4760434").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/08/07 21:40

S38	3958	((702/57) or (702/60) or (702/65) or (702/93) or (702/99) or (702/116) or (702/119) or (702/130) or (702/136)).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/05/07 17:25
S39	3	S38 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:25
S40	3	S38 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:28
S41	2	("7176508").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/05/07 17:33
S42	4662	((702/170) or (702/182) or (702/183) or (702/189) or (702/193)).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/05/07 17:36
S43	1	S42 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:36
S44	2987	(257/59).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/05/07 17:38
S45	7	S44 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:38
S46	0	S45 and (extrapolat \$6 with contact\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:39
S47	0	S40 and (extrapolat \$6 with contact\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:40
S48	3822	(257/347).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/05/07 17:40

S49	5	S48 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:40
S50	0	S49 and (extrapolat \$6 with contact\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:40
S51	1948	(257/401).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/05/07 17:40
S52	2	S51 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:40
S53	0	S52 and (extrapolat \$6 with contact\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:40
S54	926	(257/577).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/05/07 17:41
S55	4	S54 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:41
S56	0	S55 and (extrapolat \$6 with contact\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:41
S57	1863	(257/706).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/05/07 17:41
S58	0	S57 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:41
S59	0	S58 and (extrapolat \$6 with contact\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:41
S60	420	(438/163).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/05/07 17:41
S61	0	S60 and (change with resistance with temperature) and polysilicon	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:41
S62	0	S61 and (extrapolat \$6 with contact\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:41

S63	0	S39 and (extrapolat \$6 with contact\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:42
S64	0	S40 and (extrapolat \$6 with contact\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:42
S65	0	S43 and (extrapolat \$6 with contact\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/05/07 17:42

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